

C1825X332JFGALTU

Aliases (C1825X332JFGAL7800)

SMD Comm COG HV Flex, Ceramic, 3300 pF, 5%, 1500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1825



Click here for the 3D model.

Dimensions	,
Chip Size	1825
L	4.6mm +/-0.4mm
W	6.4mm +/-0.4mm
Т	1.6mm +/-0.20mm
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

General Information	n
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	724b81dc-0c36-4aa3-aabc-63f2cc6f8822
Termination	Flexible Termination With Lead (SnPb)
Marking	No
AEC-Q200	No
Component Weight	230 mg
Shelf Life	78 Weeks
MSL	1

Specifications	,
Capacitance	3300 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1800 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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